

## Welcome to <u>E-XFL.COM</u>

#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

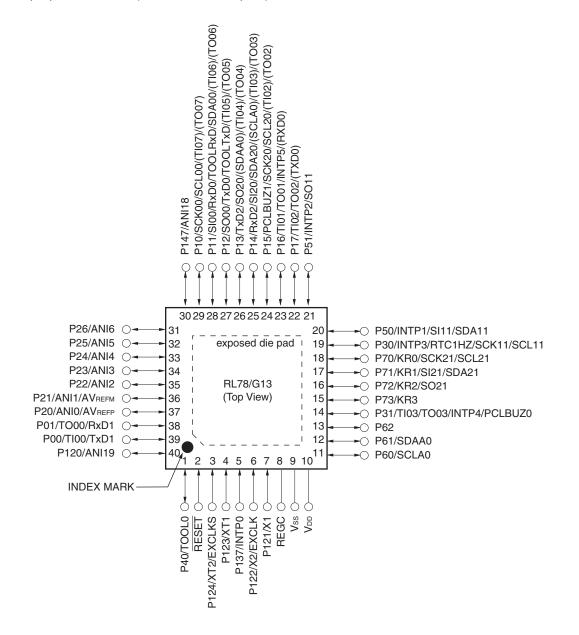
Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	21
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	30-LSSOP (0.240", 6.10mm Width)
Supplier Device Package	30-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100afasp-x0

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# 1.3.7 40-pin products

• 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)



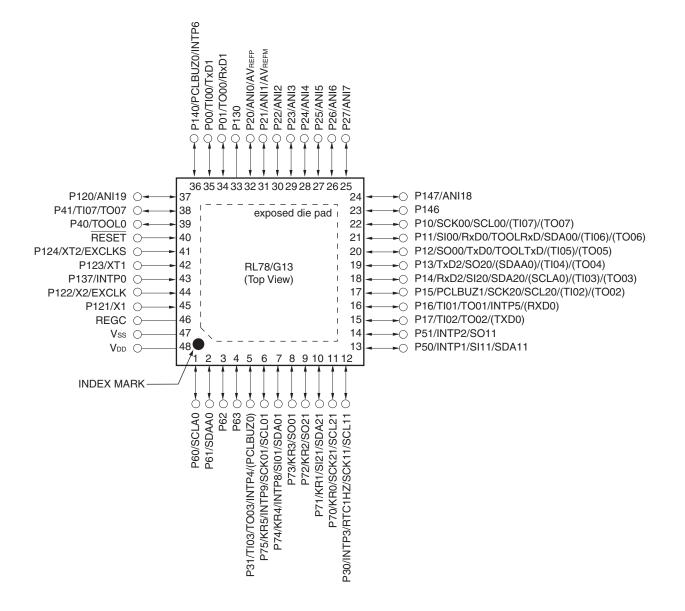


Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR) in the RL78/G13 User's Manual.
- 3. It is recommended to connect an exposed die pad to  $V_{ss.}$



• 48-pin plastic HWQFN (7 × 7 mm, 0.5 mm pitch)

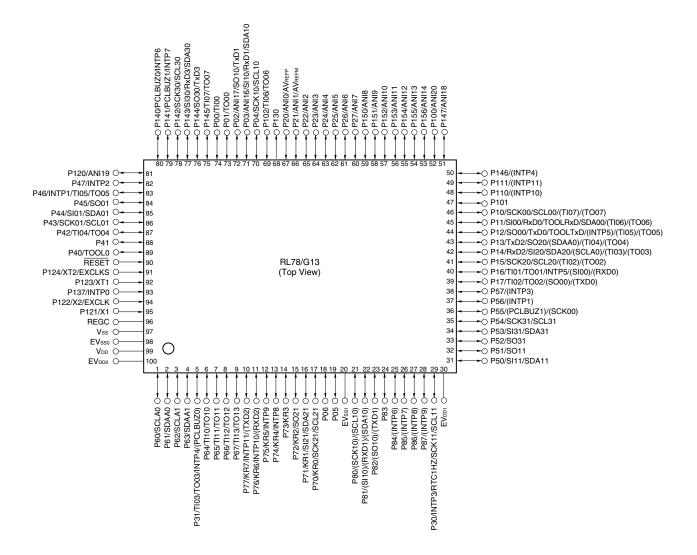


#### Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 $\mu$ F).

Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR) in the RL78/G13 User's Manual.
- 3. It is recommended to connect an exposed die pad to  $V_{\mbox{\scriptsize ss.}}$





Cautions 1. Make EVsso, EVss1 pins the same potential as Vss pin.

- 2. Make VDD pin the potential that is higher than EVDD0, EVDD1 pins (EVDD0 = EVDD1).
- 3. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F).

Remarks 1. For pin identification, see 1.4 Pin Identification.

- 2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the VDD, EVDD0 and EVDD1 pins and connect the Vss, EVss0 and EVss1 pins to separate ground lines.
- **3.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register** (**PIOR**) in the RL78/G13 User's Manual.



- The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see 6.9.3 Operation as multiple PWM output function in the RL78/G13 User's Manual).
- 4. When setting to PIOR = 1

											(2/2) 2-pin 36-pin		
Ite	m	20-	pin	24-	pin	25-	pin	30-	pin	32-	-pin	36	-pin
		R5F1006x	R5F1016x	R5F1007x	R5F1017x	R5F1008x	R5F1018x	R5F100Ax	R5F101Ax	R5F100Bx	R5F101Bx	R5F100Cx	
Clock output/buzze	er output	-	_		1		1		2		2		2
						, 1.25 Mł ) MHz op		ИHz, 5 M	Hz, 10 I	ИНz			
8/10-bit resolution	A/D converter	6 chanr	nels	6 chanı	nels	6 chanr	nels	8 chanr	nels	8 chanı	nels	8 chan	nels
Serial interface		<ul> <li>CSI:</li> <li>CSI:</li> <li>[30-pin,</li> <li>CSI:</li> <li>CSI:</li> <li>CSI:</li> <li>(36-pin)</li> <li>CSI:</li> <li>CSI:</li> <li>CSI:</li> <li>CSI:</li> </ul>	1 chann 1 chann 32-pin 1 chann 1 chann 1 chann product 1 chann 1 chann 1 chann	el/simplif products el/simplif el/simplif el/simplif el/simplif el/simplif	fied I <sup>2</sup> C: fied I <sup>2</sup> C:	1 channe 1 channe 1 channe 1 channe 1 channe 1 channe 1 channe	el/UART el/UART el/UART el/UART el/UART el/UART	: 1 chanr : 1 chanr : 1 chanr (UART s : 1 chanr : 1 chanr	nel nel supportin nel nel	-		channel	
Multiplier and divid	I <sup>2</sup> C bus ler/multiply-		_	1 chani	nel	1 chanr	nel	1 chanı	nel	1 chanı	nel	1 chan	nel
accumulator		<ul> <li>16 bits</li> <li>32 bits</li> <li>16 bits</li> </ul>	– s × 16 b s ÷ 32 b s × 16 b	1 chanı its = 32 k its = 32 k	nel bits (Uns bits (Uns	1 chanr signed or	nel signed)	1		1 chanı	nel	1 chan	nel
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accumulator	ler/multiply-	<ul> <li>16 bit</li> <li>32 bit</li> <li>16 bit</li> <li>2 chann</li> </ul>	- s × 16 b s ÷ 32 b s × 16 b nels 3	1 chani its = 32 k its = 32 k its + 32 k	nel bits (Uns bits (Uns bits = 32 24	1 chann signed or signed) bits (Uns	nel signed) signed o 24	or signed)	27		27		27
accumulator DMA controller Vectored interrupt	ler/multiply-	<ul> <li>16 bit</li> <li>32 bit</li> <li>16 bit</li> <li>2 chann</li> </ul>	- s × 16 b s ÷ 32 b s × 16 b nels	1 chani its = 32 k its = 32 k its + 32 k	nel bits (Uns bits (Uns bits = 32	1 chann signed or signed) bits (Uns	nel signed) signed o 24 5	or signed)	1				
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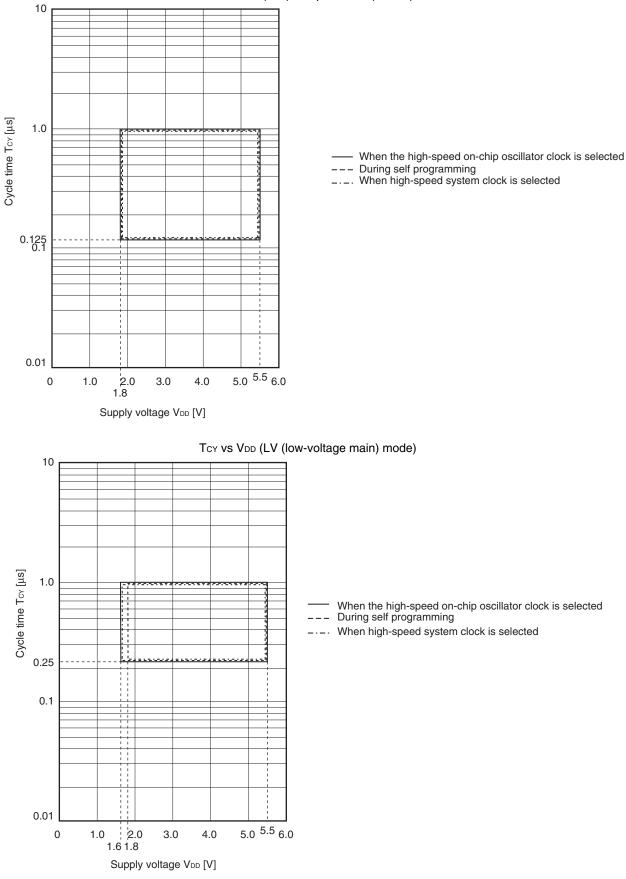
**Note** The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.



- **Notes 1.** Total current flowing into Vbb, EVbbb, and EVbb1, including the input leakage current flowing when the level of the input pin is fixed to Vbb, EVbb0, and EVbb1, or Vss, EVsso, and EVss1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. During HALT instruction execution by flash memory.
  - 3. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 4. When high-speed system clock and subsystem clock are stopped.
  - 5. When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode: 2.7 V  $\leq$  V\_DD  $\leq$  5.5 V@1 MHz to 32 MHz
      - 2.4 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 16 MHz
    - LS (low-speed main) mode:  $~~1.8~V \leq V_{\text{DD}} \leq 5.5~V~$  @ 1 MHz to 8 MHz
    - LV (low-voltage main) mode: 1.6 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 4 MHz
  - 8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.
- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is  $T_A = 25^{\circ}C$





TCY vs VDD (LS (low-speed main) mode)



3. The smaller maximum transfer rate derived by using fMcK/6 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 2.7 V  $\leq$  EV<sub>DD0</sub> < 4.0 V and 2.3 V  $\leq$  V<sub>b</sub>  $\leq$  2.7 V

Maximum transfer rate = 
$$\frac{1}{\{-C_b \times R_b \times \ln (1 - \frac{2.0}{V_b})\} \times 3}$$
 [bps]

Baud rate error (theoretical value) =  $\frac{\frac{1}{|\text{Transfer rate} \times 2|} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{|\text{Transfer rate}|}) \times \text{Number of transferred bits}} \times 100 [\%]$ 

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

- 4. This value as an example is calculated when the conditions described in the "Conditions" column are met. Refer to Note 3 above to calculate the maximum transfer rate under conditions of the customer.
- $\textbf{5.} \quad \textbf{Use it with } EV_{DD0} \geq V_{b}.$
- 6. The smaller maximum transfer rate derived by using fMCK/6 or the following expression is the valid maximum transfer rate.

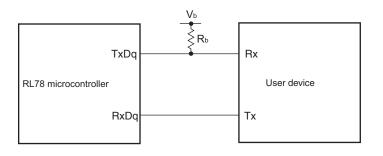
Expression for calculating the transfer rate when 1.8 V  $\leq$  EV\_{DD0} < 3.3 V and 1.6 V  $\leq$  V\_b  $\leq$  2.0 V

Maximum transfer rate = 
$$\frac{1}{\{-C_b \times R_b \times \ln (1 - \frac{1.5}{V_b})\} \times 3}$$
 [bps]

Baud rate error (theoretical value) =  $\frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 [\%]$ 

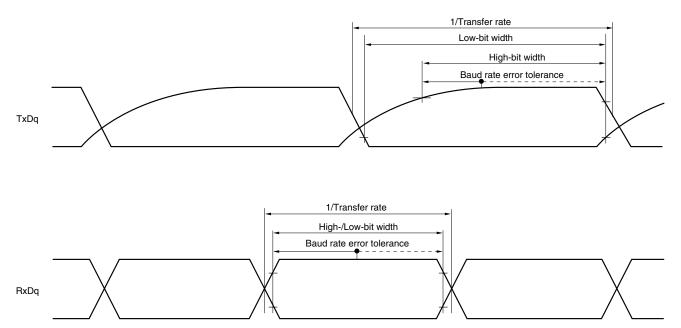
- \* This value is the theoretical value of the relative difference between the transmission and reception sides.
- **7.** This value as an example is calculated when the conditions described in the "Conditions" column are met. Refer to Note 6 above to calculate the maximum transfer rate under conditions of the customer.
- Caution Select the TTL input buffer for the RxDq pin and the N-ch open drain output (VDD tolerance (When 20- to 52-pin products)/EVDD tolerance (When 64- to 128-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For VIH and VIL, see the DC characteristics with TTL input buffer selected.

#### UART mode connection diagram (during communication at different potential)









- **2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
- **3.** fMCK: Serial array unit operation clock frequency
  (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
  m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))
- **4.** UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.



# (9) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (slave mode, SCKp... external clock input)

Parameter	Symbol		<u>≤ Vod ≤ 5.5 V, Vss =</u> nditions	HS ( speed	high- main) de	LS (low			-voltage Mode	Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time <sup>Note 1</sup>		$4.0 V \le EV_{DD0} \le 5.5 V$ , $2.7 V \le V_b \le 4.0 V$	24 MHz < fмск	14/ fмск				_		ns
			20 MHz < fмск ≤ 24 MHz	12/ fмск		_		—		ns
			8 MHz < fмск ≤ 20 MHz	10/ fмск						ns
			4 MHz < fмск ≤ 8 MHz	8/fмск		16/ fмск				ns
			fмск ≤4 MHz	<b>6/f</b> мск		10/ fмск		10/ fмск		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V	24 MHz < fмск	20/ fмск				_		ns
			20 MHz < fмск ≤ 24 MHz	16/ fмск				—		ns
			16 MHz < fмск ≤ 20 MHz	14/ fмск				_		ns
			8 MHz < fмск ≤ 16 MHz	12/ fмск						ns
			4 MHz < fмск ≤ 8 MHz	8/fмск		16/ fмск				ns
			fмск ≤4 MHz	6/fмск		10/ fмск		10/ fмск		ns
		$\begin{split} & 1.8 \ V \leq EV_{DD0} < 3.3 \ V, \\ & 1.6 \ V \leq V_b \leq 2.0 \ V^{\text{Note}} \end{split}$	24 MHz < fмск	48/ fмск		_		—		ns
		2	20 MHz < fмск ≤ 24 MHz	36/ fмск		_				ns
			16 MHz < fмск ≤ 20 MHz	32/ fмск		—		_		ns
			8 MHz < fмск ≤ 16 MHz	26/ fмск		_		_		ns
			4 MHz < fмск ≤ 8 MHz	16/ fмск		16/ fмск		_		ns
			fмск ≤4 MHz	10/ fмск		10/ fмск		10/ fмск		ns

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)



## (3) I<sup>2</sup>C fast mode plus

 $(T_A = -40 \text{ to } +85^{\circ}C, 1.6 \text{ V} \le EV_{DD0} = EV_{DD1} \le V_{DD} \le 5.5 \text{ V}, \text{ Vss} = EV_{SS0} = EV_{SS1} = 0 \text{ V})$ 

Parameter	Symbol	Cor	nditions		h-speed Mode	LS (low main)	/-speed Mode	,	LV (low-voltage main) Mode	
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLA0 clock frequency	fscL	Fast mode plus: fc∟κ≥ 10 MHz	$2.7~V \leq EV_{\text{DD0}} \leq 5.5~V$	0	1000		_	_	_	kHz
Setup time of restart condition	tsu:sta	$2.7 V \leq EV_{DD0} \leq 5.8$	5 V	0.26		-	_	_	-	μS
Hold time <sup>Note 1</sup>	thd:sta	$2.7 V \le EV_{DD0} \le 5.8$	5 V	0.26			_	_	_	μS
Hold time when SCLA0 = "L"	t∟ow	$2.7 V \leq EV_{DD0} \leq 5.8$	5 V	0.5		_	_	_	-	μS
Hold time when SCLA0 = "H"	tніgн	$2.7 V \le EV_{DD0} \le 5.8$	5 V	0.26		_	_	_	-	μS
Data setup time (reception)	tsu:dat	$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.9$	5 V	50		_	_	_	_	μS
Data hold time (transmission) <sup>Note 2</sup>	thd:dat	$2.7 V \leq EV_{DD0} \leq 5.5$	5 V	0	0.45	_	_	_	_	μS
Setup time of stop condition	tsu:sto	$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.9$	5 V	0.26		_	_	_	_	μS
Bus-free time	tвиғ	$2.7 V \le EV_{DD0} \le 5.8$	5 V	0.5		_	_	-	_	μS

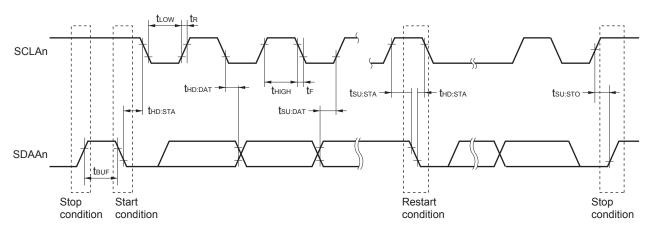
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**Notes 1.** The first clock pulse is generated after this period when the start/restart condition is detected.

- 2. The maximum value (MAX.) of the during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.
- Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (IOH1, IOL1, VOH1, VOL1) must satisfy the values in the redirect destination.
- **Remark** The maximum value of Cb (communication line capacitance) and the value of Rb (communication line pull-up resistor) at that time in each mode are as follows.

Fast mode plus:  $C_b = 120 \text{ pF}, R_b = 1.1 \text{ k}\Omega$ 

#### **IICA** serial transfer timing



**Remark** n = 0, 1



# (4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (-) = AV<sub>REFM</sub>/ANI1 (ADREFM = 1), target pin : ANI0, ANI2 to ANI14, ANI16 to ANI26

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 2.4 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, 1.6 \text{ V} \le \text{EV}_{DD0} = \text{EV}_{DD1} \le \text{V}_{DD}, \text{Vss} = \text{EV}_{SS0} = \text{EV}_{SS1} = 0 \text{ V}, \text{ Reference voltage (+)} = \text{V}_{BGR}^{\text{Note 3}}, \text{ Reference voltage (-)} = \text{AV}_{REFM} = 0 \text{ V}^{\text{Note 4}}, \text{HS (high-speed main) mode}$ 

Parameter	Symbol	Cond	MIN.	TYP.	MAX.	Unit	
Resolution	RES				8		bit
Conversion time	<b>t</b> CONV	8-bit resolution	$2.4~V \leq V_{DD} \leq 5.5~V$	17		39	μs
Zero-scale error <sup>Notes 1, 2</sup>	Ezs	8-bit resolution	$2.4~V \leq V \text{DD} \leq 5.5~V$			±0.60	%FSR
Integral linearity error <sup>Note 1</sup>	ILE	8-bit resolution	$2.4~V \leq V \text{DD} \leq 5.5~V$			±2.0	LSB
Differential linearity error Note 1	DLE	8-bit resolution	$2.4~V \leq V_{DD} \leq 5.5~V$			±1.0	LSB
Analog input voltage	VAIN			0		$V_{\text{BGR}}{}^{\text{Note 3}}$	V

Notes 1. Excludes quantization error ( $\pm 1/2$  LSB).

- 2. This value is indicated as a ratio (%FSR) to the full-scale value.
- 3. Refer to 2.6.2 Temperature sensor/internal reference voltage characteristics.

**4.** When reference voltage (-) = Vss, the MAX. values are as follows.

Zero-scale error: Add  $\pm 0.35\%$ FSR to the MAX. value when reference voltage (–) = AV<sub>REFM</sub>. Integral linearity error: Add  $\pm 0.5$  LSB to the MAX. value when reference voltage (–) = AV<sub>REFM</sub>. Differential linearity error: Add  $\pm 0.2$  LSB to the MAX. value when reference voltage (–) = AV<sub>REFM</sub>.



#### RL78/G13 3. ELECTRICAL SPECIFICATIONS (G: INDUSTRIAL APPLICATIONS TA = -40 to +105°C)

Remark The electrical characteristics of the products G: Industrial applications (T<sub>A</sub> = -40 to +105°C) are different from those of the products "A: Consumer applications, and D: Industrial applications". For details, refer to 3.1 to 3.10.

### 3.1 Absolute Maximum Ratings

Parameter	Symbols	Conditions	Ratings	Unit
Supply voltage	VDD		–0.5 to +6.5	V
	EVDD0, EVDD1	EVDD0 = EVDD1	–0.5 to +6.5	V
	EVsso, EVss1	EVsso = EVss1	–0.5 to +0.3	V
REGC pin input voltage	VIREGC	REGC	$-0.3$ to +2.8 and $-0.3$ to $V_{\text{DD}}$ +0.3 $^{\text{Note 1}}$	V
Input voltage	VI1	P00 to P07, P10 to P17, P30 to P37, P40 to P47,	-0.3 to EV <sub>DD0</sub> +0.3	V
		P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147	and –0.3 to $V_{DD}$ +0.3 <sup>Note 2</sup>	
	V <sub>I2</sub>	P60 to P63 (N-ch open-drain)	-0.3 to +6.5	V
	Vı3	P20 to P27, P121 to P124, P137, P150 to P156, EXCLK, EXCLKS, RESET	-0.3 to V <sub>DD</sub> +0.3 <sup>Note 2</sup>	V
Output voltage	Voi	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147		V
	V <sub>02</sub>	P20 to P27, P150 to P156	-0.3 to V <sub>DD</sub> +0.3 <sup>Note 2</sup>	V
Analog input voltage	VAI1	ANI16 to ANI26	$-0.3$ to EV_DD0 +0.3 and $-0.3$ to AV_{REF}(+) +0.3 $^{\text{Notes 2, 3}}$	V
	Vai2	ANI0 to ANI14	$-0.3$ to V_DD +0.3 and $-0.3$ to AV_{REF}(+) +0.3^{Notes 2, 3}	V

#### Absolute Maximum Ratings (T<sub>A</sub> = 25°C) (1/2)

- **Notes 1.** Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.
  - 2. Must be 6.5 V or lower.
  - **3.** Do not exceed AVREF(+) + 0.3 V in case of A/D conversion target pin.
- Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
- **Remarks 1.** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.
  - **2.**  $AV_{REF}(+)$  : + side reference voltage of the A/D converter.
  - **3.** Vss : Reference voltage



(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp int	ernal clock
output) (1/3)	

Parameter	Symbol		Conditions	HS (high-spee	d main) Mode	Unit
				MIN.	MAX.	
SCKp cycle time	tксүı	tkcyı ≥ 4/fclk	$\begin{array}{l} 4.0 \ V \leq EV_{\text{DD0}} \leq 5.5 \ V, \ 2.7 \ V \leq V_b \leq 4.0 \\ V, \\ C_b = 30 \ pF, \ R_b = 1.4 \ k\Omega \end{array}$	600		ns
			$\begin{array}{l} 2.7 \ V \leq EV_{DD0} < 4.0 \ V, \ 2.3 \ V \leq V_b \leq 2.7 \\ V, \\ C_b = 30 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	1000		ns
			$\begin{array}{l} 2.4 \ V \leq EV_{DD0} < 3.3 \ V, \ 1.6 \ V \leq V_b \leq 2.0 \\ V, \\ C_b = 30 \ pF, \ R_b = 5.5 \ k\Omega \end{array}$	2300		ns
SCKp high-level width	tкнı		$0.0 \text{ V} \le 60 \text{ pr}$ , $1.0 \ge 3.0 \text{ K}_2$ $0.0 \text{ V} \le 60 \text{ EV}_{\text{DD0}} \le 5.5 \text{ V}$ , $2.7 \text{ V} \le \text{V}_{\text{b}} \le 4.0 \text{ V}$ , $1.0 \text{ EV}_{\text{DD0}} \le 5.5 \text{ V}$ , $2.7 \text{ V} \le \text{V}_{\text{b}} \le 4.0 \text{ V}$ ,			ns
		2.7 V ≤ EV <sub>DD</sub> C₀ = 30 pF, F	$_{0}$ < 4.0 V, 2.3 V $\leq$ V <sub>b</sub> $\leq$ 2.7 V, R <sub>b</sub> = 2.7 kΩ	tkcy1/2 - 340		ns
		$2.4 \text{ V} \leq \text{EV}_{\text{DD}}$ $C_{\text{b}} = 30 \text{ pF}, \text{ F}$	$_{0}$ < 3.3 V, 1.6 V $\leq$ V $_{b}$ $\leq$ 2.0 V, R $_{b}$ = 5.5 k $\Omega$	tксү1/2 – 916		ns
SCKp low-level width	tĸ∟1	$4.0 \text{ V} \leq \text{EV}_{\text{DD}}$ $C_{\text{b}} = 30 \text{ pF, F}$	$_{0}\leq5.5$ V, 2.7 V $\leq$ V_{b} $\leq4.0$ V, R_{b} = 1.4 k $\Omega$	tксү1/2 – 24		ns
		$2.7 \text{ V} \leq \text{EV}_{\text{DD}}$ $C_{\text{b}} = 30 \text{ pF}, \text{ F}$	$_{0}$ < 4.0 V, 2.3 V $\leq$ V <sub>b</sub> $\leq$ 2.7 V, R <sub>b</sub> = 2.7 k $\Omega$	tксү1/2 – 36		ns
		$2.4 \text{ V} \leq \text{EV}_{\text{DD}}$ $C_{\text{b}} = 30 \text{ pF}, \text{ F}$	$_{0}$ < 3.3 V, 1.6 V $\leq$ V $_{b}$ $\leq$ 2.0 V, $R_{b}$ = 5.5 k $\Omega$	tkcy1/2 - 100		ns

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.4 \text{ V} \le \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{\text{SS0}} = \text{EV}_{\text{SS1}} = 0 \text{ V})$ 

Caution Select the TTL input buffer for the SIp pin and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 20- to 52-pin products)/EV<sub>DD</sub> tolerance (for the 64- to 100-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

(**Remarks** are listed two pages after the next page.)



Parameter	Symbol	Conditions	HS (high-spe	ed main) Mode	Unit
			MIN.		
SIp setup time	tsik1	$4.0 \ V \le EV_{\text{DD0}} \le 5.5 \ V, \ 2.7 \ V \le V_{\text{b}} \le 4.0 \ V,$	162		ns
(to SCKp↑) <sup>Note</sup>		$C_b = 30 \text{ pF}, \text{ R}_b = 1.4 \text{ k}\Omega$			
		$2.7 \ V \leq EV_{\text{DD0}} < 4.0 \ V, \ 2.3 \ V \leq V_b \leq 2.7 \ V,$	354		ns
		$C_b$ = 30 pF, $R_b$ = 2.7 k $\Omega$			
		$2.4 \text{ V} \le \text{EV}_{\text{DD0}} < 3.3 \text{ V}, \ 1.6 \text{ V} \le \text{V}_{\text{b}} \le 2.0 \text{ V},$	958		ns
		$C_b = 30 \text{ pF}, \text{ R}_b = 5.5 \text{ k}\Omega$			
Slp hold time tksi1	tksi1	$4.0 \ V \le EV_{\text{DD0}} \le 5.5 \ V, \ 2.7 \ V \le V_{\text{b}} \le 4.0 \ V,$	38		ns
(from SCKp↑) <sup>Note</sup>		$C_b = 30 \text{ pF}, \text{ R}_b = 1.4 \text{ k}\Omega$			
		$2.7 \ V \leq EV_{\text{DD0}} < 4.0 \ V, \ 2.3 \ V \leq V_b \leq 2.7 \ V,$	38		ns
		$C_b = 30 \text{ pF}, \text{ R}_b = 2.7 \text{ k}\Omega$			
		$2.4 \ V \leq EV_{\text{DD0}} < 3.3 \ V, \ 1.6 \ V \leq V_b \leq 2.0 \ V,$	38		ns
		$C_b = 30 \text{ pF}, \text{ R}_b = 2.7 \text{ k}\Omega$			
Delay time from SCKp $\downarrow$ to	tkso1	$4.0~V \leq EV_{\text{DD0}} \leq 5.5~V,~2.7~V \leq V_b \leq 4.0~V,$		200	ns
SOp output <sup>Note</sup>		$C_b = 30 \text{ pF}, \text{ R}_b = 1.4 \text{ k}\Omega$			
		$2.7 \ V \le EV_{\text{DD0}} < 4.0 \ V, \ 2.3 \ V \le V_{\text{b}} \le 2.7 \ V,$		390	ns
		$C_b$ = 30 pF, $R_b$ = 2.7 k $\Omega$			
		$2.4 \text{ V} \le \text{EV}_{\text{DD0}} < 3.3 \text{ V}, \ 1.6 \text{ V} \le \text{V}_{\text{b}} \le 2.0 \text{ V},$		966	ns
		$C_b = 30 \text{ pF}, R_b = 5.5 \text{ k}\Omega$			

(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (2/3)
 (T<sub>1</sub> = 40 to ±105°C 2.4 V ≤ EVere = EVere ≤ Vere ≤ 5.5 V, Vere = EVere = 6.V)

**Note** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.

Caution Select the TTL input buffer for the SIp pin and the N-ch open drain output (VDD tolerance (for the 20- to 52-pin products)/EVDD tolerance (for the 64- to 100-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For VIH and VIL, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the page after the next page.)



- **Notes 1.** Excludes quantization error ( $\pm 1/2$  LSB).
  - 2. This value is indicated as a ratio (%FSR) to the full-scale value.
  - $\label{eq:scalar} \begin{array}{l} \textbf{3. When } AV_{\text{REFP}} < V_{\text{DD}} \text{, the MAX. values are as follows.} \\ \text{Overall error: } Add \pm 1.0 \ \text{LSB} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \text{Zero-scale error/Full-scale error: } Add \pm 0.05\%\text{FSR} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \text{Integral linearity error/ Differential linearity error: } Add \pm 0.5 \ \text{LSB} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \end{array}$
  - 4. Refer to 3.6.2 Temperature sensor/internal reference voltage characteristics.

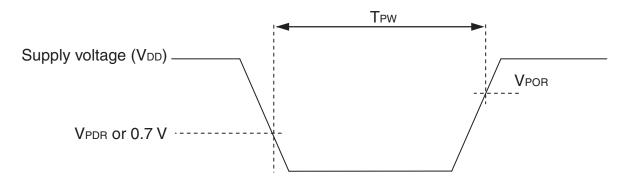


## 3.6.3 POR circuit characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{ Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	VPOR	Power supply rise time	1.45	1.51	1.57	V
	VPDR	Power supply fall time	1.44	1.50	1.56	V
Minimum pulse width	TPW		300			μs

**Note** Minimum time required for a POR reset when V<sub>DD</sub> exceeds below V<sub>PDR</sub>. This is also the minimum time required for a POR reset from when V<sub>DD</sub> exceeds below 0.7 V to when V<sub>DD</sub> exceeds V<sub>POR</sub> while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).





3.6.5 Power supply voltage rising slope characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Power supply voltage rising slope	SVDD				54	V/ms

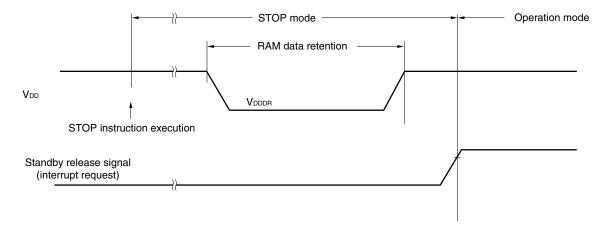
Caution Make sure to keep the internal reset state by the LVD circuit or an external reset until  $V_{DD}$  reaches the operating voltage range shown in 3.4 AC Characteristics.

### 3.7 RAM Data Retention Characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	VDDDR		1.44 <sup>Note</sup>		5.5	V

**Note** This depends on the POR detection voltage. For a falling voltage, data in RAM are retained until the voltage reaches the level that triggers a POR reset but not once it reaches the level at which a POR reset is generated.





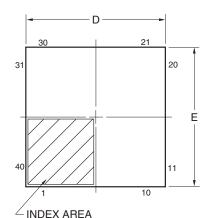
# 4.7 40-pin Products

R5F100EAANA, R5F100ECANA, R5F100EDANA, R5F100EEANA, R5F100EFANA, R5F100EGANA, R5F100EHANA R5F101EAANA, R5F101ECANA, R5F101EDANA, R5F101EEANA, R5F101EFANA, R5F101EGANA, R5F101EHANA R5F100EADNA, R5F100ECDNA, R5F100EDDNA, R5F100EEDNA, R5F100EFDNA, R5F100EGDNA, R5F100EHDNA

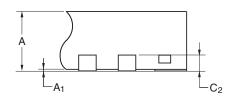
R5F101EADNA, R5F101ECDNA, R5F101EDDNA, R5F101EEDNA, R5F101EFDNA, R5F101EGDNA, R5F101EHDNA

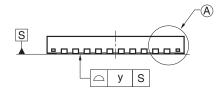
R5F100EAGNA, R5F100ECGNA, R5F100EDGNA, R5F100EEGNA, R5F100EFGNA, R5F100EGGNA, R5F100EHGNA

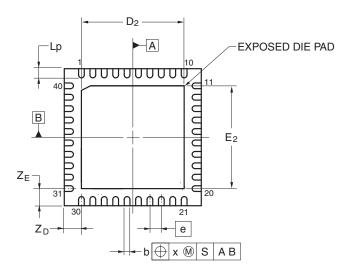
JEITA Package code	RENESAS code	Previous code	MASS (TYP.) [g]
P-HWQFN40-6x6-0.50	PWQN0040KC-A	P40K8-50-4B4-5	0.09



Detail of (A) Part







Referance	Dimension in Millimeters			
Symbol	Min	Nom	Max	
D	5.95	6.00	6.05	
E	5.95	6.00	6.05	
A			0.80	
A <sub>1</sub>	0.00			
b	0.18	0.25	0.30	
е		0.50		
Lp	0.30	0.40	0.50	
х			0.05	
у			0.05	
ZD		0.75	—	
Z <sub>E</sub>		0.75	—	
C <sub>2</sub>	0.15	0.20	0.25	
D <sub>2</sub>		4.50		
E <sub>2</sub>		4.50		

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# 4.9 48-pin Products

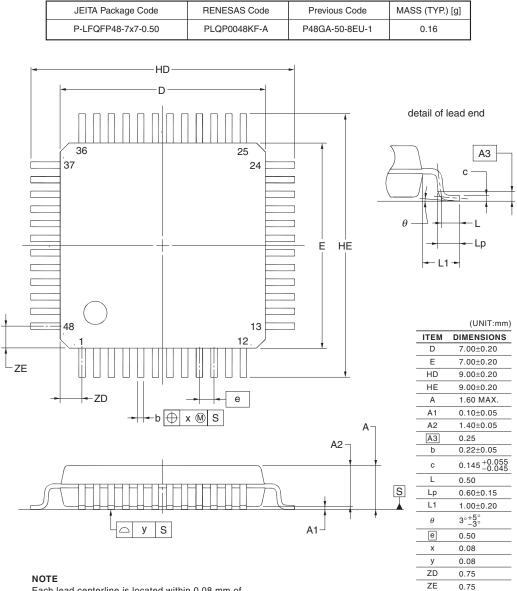
R5F100GAAFB, R5F100GCAFB, R5F100GDAFB, R5F100GEAFB, R5F100GFAFB, R5F100GGAFB, R5F100GHAFB, R5F100GJAFB, R5F100GLAFB

R5F101GAAFB, R5F101GCAFB, R5F101GDAFB, R5F101GEAFB, R5F101GFAFB, R5F101GGAFB, R5F101GHAFB, R5F101GJAFB, R5F101GKAFB, R5F101GLAFB

R5F100GADFB, R5F100GCDFB, R5F100GDDFB, R5F100GEDFB, R5F100GFDFB, R5F100GGDFB, R5F100GHDFB, R5F100GJDFB, R5F100GKDFB, R5F100GLDFB

R5F101GADFB, R5F101GCDFB, R5F101GDDFB, R5F101GEDFB, R5F101GFDFB, R5F101GGDFB, R5F101GHDFB, R5F101GJDFB, R5F101GKDFB, R5F101GLDFB

R5F100GAGFB, R5F100GCGFB, R5F100GDGFB, R5F100GEGFB, R5F100GFGFB, R5F100GGGFB, R5F100GHGFB, R5F100GJGFB



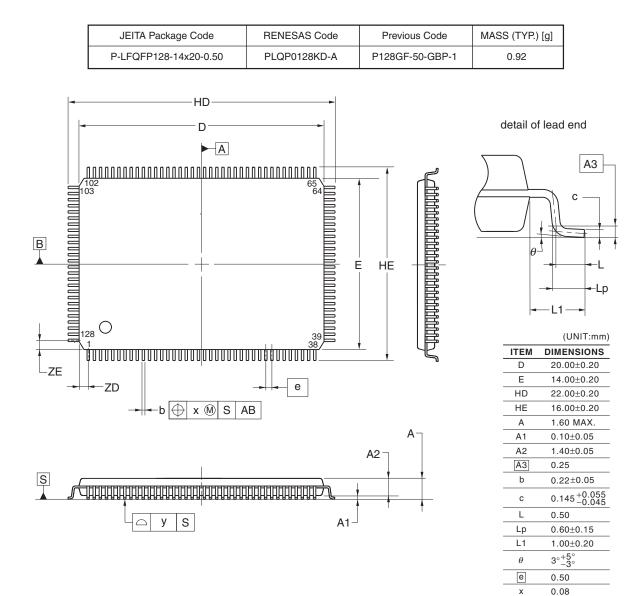
Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

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# 4.14 128-pin Products

R5F100SHAFB, R5F100SJAFB, R5F100SKAFB, R5F100SLAFB R5F101SHAFB, R5F101SJAFB, R5F101SKAFB, R5F101SLAFB R5F100SHDFB, R5F100SJDFB, R5F100SKDFB, R5F100SLDFB R5F101SHDFB, R5F101SJDFB, R5F101SKDFB, R5F101SLDFB



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х

y ZD

ZE

0.08

0.75

0.75

